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54 **Substrate for planographic plate.**

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**Description**

## Background of the invention

This invention relates to a substrate for planographic (lithographic) plate having excellent printing  
5 aptitude and printing resistance.

In general, metals such as aluminum or stainless steel sheets have been employed as a substrate for  
planographic plate.

However, a substrate for planographic plate of a metallic single substance is heavy with poor  
workability and also expensive.

10 Accordingly, a printing plate structure with an aluminum sheet (foil) laminated on one surface of a  
thermoplastic resin sheet has been proposed (Japanese Patent Publication No. 41362/1976).

However, the substrate by use of one-surface metal foil laminated sheet is liable to be curled, and the  
printing plate by use of this sheet is also poor in printing resistance and printing aptitude, thus failing to be  
suitable for a printing substrate.

15 Accordingly, for suppression of generation of curl in the one-surface metal foil laminated sheet, a  
substrate for planographic plate by use of a sheet prepared from a mixture of a polyolefin resin and an  
inorganic filler as a thermoplastic resin sheet was proposed.

However, such a substrate for planographic plate proved to involve the problem that the printing plate  
by use of this sheet is poor in printing resistance, particularly in printing resistance in multiple printing (e.g.  
20 multicolor printing) in which some tens of thousands sheets are to be printed, and therefore limited in uses.

## Summary of the invention

The present inventors have studied intensively to provide a substrate for planographic plate by  
combination of a thermoplastic resin sheet and a metal foil, having no problem as mentioned above, and  
25 consequently accomplished the present invention.

More specifically, the present invention concerns a substrate for planographic plate, which comprises  
metal foils with thicknesses of 5 to 100  $\mu$  laminated on both surfaces of a sheet with a thickness of 30 to 400  
 $\mu$ , said sheet being obtained by sheet making of a modified polyolefin composite material comprising 100  
parts by weight of a modified polyolefin resin graft-modified partially or wholly with an organic silane  
30 compound and 5 to 150 parts by weight of mica.

## Description of the preferred embodiments

In the present invention, by using a sheet with a thickness of 30 to 400  $\mu$  obtained by sheet making of a  
modified polyolefin composite material comprising 100 parts by weight of a modified polyolefin resin  
35 graft-modified partially or wholly with an organic silane compound and 5 to 150 parts by weight of mica as  
the resin sheet to be laminated with metal foils, printing resistance and printing aptitude of a substrate for  
planographic plate can be improved without generation of curl.

The polyolefin resin to be used for obtaining the above modified polyolefin resin may include  
crystalline homopolymers of propylene, crystalline random or block copolymers of propylene with  
40 ethylene or other  $\alpha$ -olefins (e.g. butene-1, pentene, hexene, heptene, octene-1, etc.), propylene resins such  
as crystalline terpolymers of propylene, ethylene and other  $\alpha$ -olefins, ethylene homopolymers with a  
density of 0.93 g/cm<sup>3</sup> or more and copolymers of ethylene with  $\alpha$ -olefins, preferably polypropylene resins.  
The polyolefin resin typically have a melt flow rate index (MFR) of 3 to 30 g/10 min and may preferably have  
a melt flow rate index (MFR) of 0.1 to 100 g/10 min corresponding to a molecular weight of about  $7.0 \times 10^5$  to  
45  $8.0 \times 10^4$ , respectively.

As the above organic silane compound, there may be mentioned a silane compound having an  
unsaturated bond, such as vinyl triethoxysilane, methacryloyloxy trimethoxysilane,  $\gamma$ -methacryloyloxy  
propyltrimethoxysilane, methacryloyloxy cyclohexyltrimethoxysilane,  $\gamma$ -methacryloyloxy propyltri-  
acetyloxysilane, methacryloyloxy triethoxysilane,  $\gamma$ -methacryloyloxy propyltriethoxysilane and the like.  
50 These organic silane compounds may be used either alone or as a mixture of two or more compounds.

The modified polyolefin resin to be used in the present invention is prepared by the graft reaction of at  
least a part of the above polyolefin resins with an organic silane compound, preferably in the presence of  
an organic peroxide.

The above organic peroxide may preferably be one with a one minute half-life period temperature of  
55 about 160 to 260°C, and such organic peroxides may include, for example, tert-butyl peroxyisopropyl  
carbonate, di-tert-butyl diperoxyphthalate, tert-butyl peroxyacetate, 2,5 - dimethyl - 2,5 - di(tert -  
butylperoxy)hexane, 2,5 - dimethyl - 2,5 - di(tert - butylperoxy)hexyne - 3, tert - butyl peroxy laurate,  
tert - butyl peroxy maleic acid, tert - butyl peroxy benzoate, methyl ethyl ketone peroxide, dicumyl  
peroxide, cyclohexanone peroxide, tert-butyl cumyl peroxide, 2,5 - dimethylhexane 2,5 - dihydroperoxide  
60 and the like. These organic peroxides may be used either singly or as a mixture of two or more compounds.

The modified polyolefin resin may be prepared preferably by mixing 100 parts by weight of a  
polyolefin resin, preferably a polypropylene resin, 0.01 to 5 parts by weight, preferably 0.05 to 3 parts by  
weight, of an organic silane compound and 0.01 to 5 parts by weight, preferably 0.05 to 2 parts by weight,  
of an organic peroxide and heating the resultant mixture to as temperature of 160 to 270°C, preferably 180  
65 to 270°C to effect grafting. The most simple heat treatment operation may be conducted by melt heating of

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the above mixture in an extruder at the above temperature from about 1 to 10 minutes. Particularly, there may preferably be used a modified polypropylene having an MFR of 10 to 80 g/10 min, which is obtained by graft modification of a polypropylene resin so as to have an MFR of 5 to 200 g/10 min, followed by crosslinking with water (including also water vapor). Water crosslinking means formation of a Si—O—Si linkage which is considered to be caused by elimination of methanol upon contact with water. The aforesaid water crosslinking (including also water vapor crosslinking) can be achieved preferably by bringing the above modified polypropylene resin into contact with water vapor under an atmosphere containing water vapor (which may be also in the air) at 25 to 120°C for one hour or longer, preferably 24 hours or longer. In the present invention, the above modified polyolefin alone or more preferably, a mixture of the above modified polyolefin resin with an unmodified polyolefin resin (preferably having a MFR of 0.1 to 10 g/10 min) may be used. When such a mixture is to be employed, it is preferred to mix 5 to 150 parts by weight of the modified polyolefin resin per 100 parts by weight of the unmodified polyolefin resin. The thus obtained modified polyolefin resin subjected partially or wholly to graft modification with an organic silane compound should preferably have a MFR of 0.3 to 80 g/10 min, particularly preferably 0.3 to 10 g/10 min from the standpoint of moldability and the physical properties of the sheet.

In the present invention, mica such as common mica (potashmica or muscovite), biotite, phlogopite and synthetic mica (artificial mica) is employed as the inorganic filler. Among them, phlogopite may preferably be used. The mica to be used in the present invention should preferably have a mean size (weight average mean value) of 10 to 280  $\mu$ , with a mean aspect ratio of 15 to 70, particularly containing 2 wt. % or less of flakes with diameters of 600  $\mu$  or more. The mica may be subjected to the surface treatment with a surface treating agent such as aminosilane. The amount of mica to be formulated may be 5 to 150 parts by weight, preferably 10 to 150 parts by weight, particularly preferably 20 to 100 parts by weight, per 100 parts by weight of the modified polyolefin resin graft-modified partially or wholly with a silane compound. If the amount of mica formulated is less than 5 parts by weight, the effect of improvement of printing resistance of the substrate for planographic plate is small, while an amount in excess of 150 parts by weight will contrariwise lower printing resistance.

The substrate for planographic plate of the present invention can be obtained by, for example, laminating metal foils with a thickness of 5 to 100  $\mu$ , preferably 10 to 50  $\mu$ , directly or through an adhesive on both surfaces of a sheet with a thickness of 10 to 400  $\mu$ , preferably 100 to 280  $\mu$ , prepared by sheet making of a modified polyolefin composite material comprising a mixture obtained by heating the above modified polyolefin resin or the modified polyolefin resin and unmodified polyolefin resin together with mica (the polyolefin resin may be graft-modified by a silane compound during mixing of the polyolefin resin with mica). The laminated substrate should preferably have a thickness of 100 to 500  $\mu$  and a weight of 0.6 kg/m<sup>2</sup> or less.

As the above metal foils, there may be used aluminum and stainless foils on both surfaces, and there may preferably be employed aluminum foils. Particularly, it is preferred to use rigid aluminum foils with an elongation of 3% or less.

The above adhesive may be any of the solution type, the emulsion type and the hot melt type, as exemplified by epoxy resin, chlorinated polypropylene, polyurethane, modified polyolefin resin, ethylene-vinyl acetate copolymer, ionomer resin, epoxidized 1,2-polybutadiene, etc.

In the present invention, a photosensitive resin layer is provided on at least one surface of the metal foils laminated on both surfaces of the sheet obtained by sheet making of the above composite material (resin sheet) and used as the planographic plate (printing plate).

In laminating these metal foils, respective treatments of (sand) blasting of the surface *et seq* may be conducted, followed by coating of the photosensitive resin to prepare a planographic plate (printing plate). Alternatively, the surface of the metal foils may be subjected to (sand) blasting and, in some cases, further subjected to pre-treatments such as anodic oxidation treatment or various hydrophilic treatments before lamination of the metal foils, followed by coating with the photosensitive resin to prepare a planographic plate. It is also possible to apply the pre-treatments of (sand) blasting *et seq* and the photosensitive resin coating before lamination to prepare a planographic plate. Further, it is possible to apply the pre-treatments of (sand) blasting *et seq* and the photosensitive resin coating, followed by cutting of the coated product to suitable sizes, which are then laminated after the plate manufacturing steps to prepare a planographic plate.

As the method for laminating metal foils on both surfaces of the resin sheet, there may be employed the two-step roll method in which an adhesive is first applied on one surface of a metal foil or a resin sheet and a composite of three layers of metal foil/adhesive/resin sheet is passed through pressure rollers and then the other metal foil is laminated similarly on the resin sheet surface of the three layer, or the one-step roll method in which the above respective layers are laminated at once.

The substrate for planographic plate of the present invention has the advantages of difficult generation of curl, substantially equal performance as compared with the substrate of a single metal and excellent working properties with light weight.

In the following Examples, parts mean parts by weight.

### Example 1

A mixture of 100 parts of a crystalline polypropylene homopolymer having a MFR of 9.0 g/10 min with

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0.5 parts of  $\gamma$ -methacryloyloxy propyltrimethoxysilane and 0.25 parts of t-butylperoxy benzoate was subjected to heating decomposition in an extruder at a resin temperature of 220°C. The modified polypropylene obtained immediately after the modification (MFR 100 g/10 min) was subjected to water crosslinking in the air at 80°C for about 3 days. 14 Parts of the pellets (2 mm $\phi$ ×3 mm) of the resultant modified polypropylene (MFR 50 g/10 min), 56 parts of pellets (2 mm $\phi$ ×3 mm) of a crystalline polypropylene homopolymer (MFR 0.5 g/10 min) (further 0.1 phr of BHT, 0.1 phr of Irganox 1010 (trade name, produced by Ciba-Geigy of Japan) and 0.2 phr of calcium stearate were added) and 30 parts of mica [Suzorite mica 325 HK, mean particle size 20  $\mu$ , mean aspect ratio 20—25, containing 1 wt. % or more of flakes of 100  $\mu$  or more, (produced by Kuraray K.K.)] were mixed homogeneously by means of a continuous biaxial kneading machine, FCM (produced by Kobe Seikosho K.K.) at 200°C to obtain a composite material.

This material was formed into a sheet, according to the T-die method, by use of a sheet molding machine, NRM (produced by Mitsubishi Jyukogyo K.K.) at a molding temperature of 200°C to obtain a sheet with a thickness of 240  $\mu$  and a width of 1 m. The mechanical properties of the thus obtained sheet are:

15	Tensile strength:	3.96 kg/mm <sup>2</sup> (MD), 3.82 kg/mm <sup>2</sup> (TD)
	Elongation:	10% (MD), 4% (TD)
	Tensile modulus of elasticity:	310 kg/mm <sup>2</sup> (MD) 291 kg/mm <sup>2</sup> (TD)

20 On both surfaces of this sheet, aluminum foils with a thickness of 30  $\mu$  (elongation 2.0%, rigid 1N30H) were laminated with the use of an urethane type adhesive (5 g/m<sup>2</sup> on front surface, 10 g/m<sup>2</sup> on back surface) according to the roll method to obtain a sheet laminated on both surfaces with aluminum foils with a thickness of about 300  $\mu$  and a weight of about 0.4 kg/m<sup>2</sup>.

For the laminated sheet which was cut into pieces having a size of 560 mm×670 mm, evaluation as a substrate for planographic plate were conducted according to the following method.

### Evaluation method

The aluminum surface on the front side (mirror surface side) of the laminated sheet was subjected to sand blasting working with the use of abrasives of appropriate particle sizes (surface coarseness: about 1.5  $\mu$ ) and hydrophilic treatment, and then a commercially available photosensitive resin was applied thereon to prepare a planographic plate.

For this planographic plate, printing resistance test was conducted in an off-set printing machine under the following conditions.

#### 35 1. Preparation of plate

- (i) Exposure: Ultra-high pressure mercury lamp 2 KW;
- (ii) Developing: Sakura PS plate automatic developing machine 860 A (produced by Konishiroku Photo Industry Co., Ltd.); Developer: Sakura SDP-1 (produced by Konishiroku Photo Industry Co., Ltd.).

#### 40 2. Printing machine test method

- (i) Printing machine: 480 K off-set printing machine (produced by Ryobi K.K.);  
Ink: four colors of process red, yellow, blue and black.
- (ii) Printing speed: 10000 rpm.

45 Printing resistance was evaluated from the changes in dot area and dot density at the shadow portion and the highlight portion of the printed product and further from the reflected density change at the gray scale portion.

From the beginning of printing to printing of 50000 sheets, no such phenomenon as slendering of dots or lowering in ink attachment at image lines was recognized at all, and good printing aptitude was retained.

50 During printing, badness percentage due to breaking at the nip portion on mounting of the printing plate on printing rolls was found to be 0% (tested for each of 5 sheets).

### Example 2

55 A composite material was obtained in the same manner as in Example 1 except that the formulated ratios of the respective components were changed as 14 parts for the modified polypropylene (MFR 50 g/10 min), 36 parts for the crystalline polypropylene homopolymer (MFR 0.5 g/10 min) and 50 parts for the mica (325 HK).

60 By use of this composite material, a laminated sheet (substrate for planographic plate) and then a planographic plate were prepared similarly as in Example 1. The mechanical properties of the thus obtained sheet are:

65	Tensile strength:	4.18 kg/mm <sup>2</sup> (MD), 3.94 kg/mm <sup>2</sup> (TD)
	Elongation:	5% (MD), 3% (TD)
	Tensile modulus of elasticity:	425 kg/mm <sup>2</sup> (MD) 418 kg/mm <sup>2</sup> (TD).

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When printing resistance test was conducted for this planographic plate similarly as described in Example 1, good printing aptitude was found to be retained without any phenomenon such as slendering of dots, lowering in ink attachment at image lines, etc. from the beginning of printing to 50000 sheets of printing.

5 The badness percentage due to breaking at the nip portion during printing was found to be 0% (tested for each of 5 sheets).

### Comparative Example 1

As the composite material, a crystalline polypropylene homopolymer was employed. The mechanical properties of the sheet are as follows:

Tensile strength:	3.83 kg/mm <sup>2</sup> (MD), 3.84 kg/mm <sup>2</sup> (TD)
Elongation:	430% (MD), 520% (TD)
Tensile modulus of elasticity:	147 kg/mm <sup>2</sup> (MD)
	139 kg/mm <sup>2</sup> (TD).

On one surface of the sheet with a thickness of 270  $\mu$  obtained by sheet making of the polymer was laminated an aluminum foil with a thickness of 30  $\mu$  by use of an urethane type adhesive to obtain a laminated sheet laminated on one surface with aluminum foil with a thickness of about 300  $\mu$ .

20 The laminated sheet was curled greatly, thus being unsuitable as a printing substrate, and therefore no printing resistance test was conducted.

### Comparative Example 2

As the composite material, a crystalline polypropylene homopolymer having the same mechanical properties as in Comparative Example 1 was employed, and on both surfaces of the sheet with a thickness of 240  $\mu$  obtained by sheet making of the polymer, aluminum foils with a thickness of 30  $\mu$  were laminated according to the roll method by use of an urethane type adhesive to obtain a sheet laminated on both surfaces with aluminum foils with a thickness of about 300  $\mu$ , from which a planographic plate was then prepared.

30 When printing resistance test was conducted for this planographic plate, slendering of dots was recognized locally from the beginning of printing, thus involving the problem in printing resistance.

### Examples 3 to 5

Experiments for Examples 3 to 5 were conducted according to the same manner as in Example 1 except that as mica Suzorite mica 325S [mean particle size 40  $\mu$ , mean aspect ratio 30, containing 1 wt. % or less of flakes of 210  $\mu$  or more (produced by Kuraray K.K.)] was used in Example 3; Suzorite mica 325K-1 [a grade which has been obtained by subjecting 325S to surface treatment thereof with an aminosilane (produced by Kuraray K.K.)] in Example 4; and Suzorite mica 350K-1 [a grade which has been obtained by subjecting 325HK to surface treatment thereof with an aminosilane (produced by Kuraray K.K.)] in Example 5, respectively, in place of Suzorite mica 325HK.

These Examples provided good results which are almost the same as in Example 1.

As described above, according to the present invention, it is possible to obtain a substrate for planographic plate which is light in weight and easy in handling, and has excellent printing aptitude and printing resistance.

## Claims

1. A substrate for planographic plate, which comprises metal foils with thicknesses of 5 to 100  $\mu$  laminated on both surfaces of a sheet with a thickness of 30 to 400  $\mu$ , said sheet being obtained by sheet making of a modified polyolefin composite material comprising 100 parts by weight of a modified polyolefin resin graft-modified partially or wholly with an organic silane compound and 5 to 150 parts by weight of mica.

2. The substrate for planographic plate according to Claim 1, wherein the modified polyolefin resin is a modified polypropylene resin.

3. The substrate for planographic plate according to Claim 1, wherein the metal foils are aluminum foils.

4. The substrate for planographic plate according to Claim 1, wherein the metal foils have a thickness of 10 to 50  $\mu$ .

5. The substrate for planographic plate according to Claim 3, wherein aluminum foils have a tensile elongation of 3% or less.

6. The substrate for planographic plate according to Claim 1, wherein the mica has a mean size of 10 to 280  $\mu$  and a mean aspect ratio (mean size/mean thickness) of 15 to 70.

7. The substrate for planographic plate according to Claim 6, wherein the mica has a mean size of 20 to 50  $\mu$  and a mean aspect ratio (mean size/mean thickness) of 20 to 40.

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8. The substrate for planographic plate according to Claim 1, wherein the amount of the mica is 20 to 100 parts by weight.

9. The substrate for planographic plate according to Claim 1, wherein the organic silane compound is vinyl triethoxysilane, methacryloyloxy trimethoxysilane,  $\gamma$ -methacryloyloxy propyltrimethoxysilane, methacryloyloxy cyclohexyltrimethoxysilane,  $\gamma$ -methacryloyloxy propyltriacetyloxysilane, methacryloyloxy triethoxysilane or  $\gamma$ -methacryloyloxy propyltriethoxysilane.

10. The substrate for planographic plate according to Claim 9, wherein the organic silane compound is  $\gamma$ -methacryloyloxy propyltrimethoxysilane.

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### Patentansprüche

1. Substrat für Flachdruckplatten, bestehend aus 5 bis 100  $\mu$  dicken, auf beide Flächen eines 30 bis 400  $\mu$  dicken Blatts laminierten Metallfolien, wobei dieses Blatt durch Blattbildung aus einem modifizierten Polyolefinverbundstoff erhalten wird, der aus 100 Gewichtsteilen eines teilweise oder ganz mit einer organischen Silanverbindung Pfropf-modifizierten Polyolefinharzes und 5 bis 150 Gewichtsteilen Glimmer besteht.

2. Substrat für Flachdruckplatten nach Anspruch 1, worin das modifizierte Polyolefinharz ein modifiziertes Polypropylenharz ist.

3. Substrat für Flachdruckplatten nach Anspruch 1, worin die Metallfolien Aluminiumfolien sind.

4. Substrat für Flachdruckplatten nach Anspruch 1, worin die Metallfolien eine Stärke von 10 bis 50  $\mu$  aufweisen.

5. Substrat für Flachdruckplatten nach Anspruch 3, worin die Aluminiumfolien eine Zugdehnung von 3% oder weniger aufweisen.

6. Substrat für Flachdruckplatten nach Anspruch 1, worin der Glimmer eine durchschnittliche Größe von 10 bis 280  $\mu$  und ein durchschnittliches Längenverhältnis (durchschnittliche Größe/durchschnittliche Dicke) von 15 bis 70 besitzt.

7. Substrat für Flachdruckplatten nach Anspruch 6, worin der Glimmer eine durchschnittliche Größe von 20 bis 50  $\mu$  und ein durchschnittliches Längenverhältnis (durchschnittliche Größe/durchschnittliche Dicke) von 20 bis 40 besitzt.

8. Substrat für Flachdruckplatten nach Anspruch 1, worin die Glimmermenge 20 bis 100 Gewichtsteile beträgt.

9. Substrat für Flachdruckplatten nach Anspruch 1, worin die organische Silanverbindung Vinyltriäthoxysilan, Methacryloyloxytrimethoxysilan,  $\gamma$ -Methacryloyloxypropyltrimethoxysilan, Methacryloyloxy-cyclohexyltrimethoxysilan,  $\gamma$ -Methacryloyloxypropyltriacetyloxysilan, Methacryloyloxytriäthoxysilan oder  $\gamma$ -Methacryloyloxypropyltriäthoxysilan ist.

10. Substrat für Flachdruckplatten nach Anspruch 9, worin die organische Silanverbindung  $\gamma$ -Methacryloyloxypropyltrimethoxysilan ist.

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### Revendications

1. Substrat pour plaque planigraphique, qui comprend des feuilles métalliques ayant des épaisseurs de 5 à 100  $\mu\text{m}$ , appliquées sur les deux surfaces d'une feuille d'épaisseur 30 à 400  $\mu\text{m}$ , ladite feuille étant obtenue par transformation en feuille d'une matière composite de polyoléfine modifiée comprenant 100 parties en poids d'une résine de polyoléfine modifiée, partiellement ou totalement, avec un composé silane organique et 5 à 150 parties en poids de mica.

2. Substrat pour plaque planigraphique selon la revendication 1, dans lequel la résine de polyoléfine modifiée est une résine de polypropylène modifiée.

3. Substrat pour plaque planigraphique selon la revendication 1, dans lequel les feuilles métalliques sont des feuilles d'aluminium.

4. Substrat pour plaque planigraphique selon la revendication 1, dans lequel les feuilles métalliques ont une épaisseur de 10 à 50  $\mu\text{m}$ .

5. Substrat pour plaque planigraphique selon la revendication 3, dans lequel les feuilles d'aluminium ont un allongement à la rupture inférieur ou égal à 3%.

6. Substrat pour plaque planigraphique selon la revendication 1, dans lequel le mica a une dimension moyenne de 10 à 280  $\mu\text{m}$  et un rapport de côtés moyen (dimension moyenne/épaisseur moyenne) de 15 à 70.

7. Substrat pour plaque planigraphique selon la revendication 6, dans lequel le mica a une dimension moyenne de 20 à 50  $\mu\text{m}$  et un rapport de côtés moyen (dimension moyenne/épaisseur moyenne) de 20 à 40.

8. Substrat pour plaque planigraphique selon la revendication 1, dans lequel la quantité de mica est de 20 à 100 parties en poids.

9. Substrat pour plaque planigraphique selon la revendication 1, dans lequel le composé silane organique est le vinyltriéthoxysilane, le méthacryloyloxytriméthoxysilane, le  $\gamma$ -méthacryloyloxypropyl-

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triméthoxysilane, le méthacryloyloxy cyclohexyltriméthoxysilane, le  $\gamma$  - méthacryloyloxypropyltri - acétyloxysilane, le méthacryloyloxytriéthoxysilane ou le  $\gamma$ -méthacryloyloxypropyltriéthoxysilane.

10. Substrat pour plaque planigraphique selon la revendication 9, dans lequel le composé silane organique est le  $\gamma$ -méthacryloyloxypropyltriméthoxysilane.

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